

# PATENT ABSTRACTS OF JAPAN

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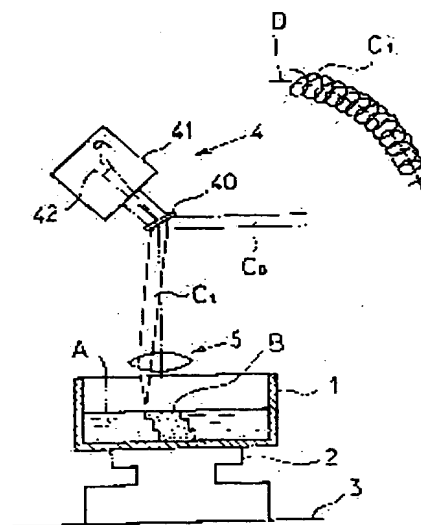
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## (54) OPTICAL SHAPING

### (57)Abstract:

**PURPOSE:** To shape the solid of a desired thickness with a high dimensional accuracy by a method wherein projecting light flux is moved along a main path as a whole while effecting repeated micro-motions covering the main path along the sectional configuration of a solid to be shaped and the periphery of the main path to shape the sectional configuration.

**CONSTITUTION:** When laser beams are projected against a plane mirror 40 while rotating the plane mirror 40 about an axial line 42 by a driving unit 41, reflecting light oscillates along a conical surface having the central angle of  $2\alpha$  and the beams are collected on a photo-setting substance A through a lens device 5. According to this method, light projection, accompanied by repeated micro-motions, can be effected. A vessel 1 is moved relatively with respect to the laser beams C1 by a position control unit 2 while effecting the repeated micro-motions and the laser beams C1 are moved relatively along the main path along the configuration of the solid to be shaped, then, a desired sectional configuration may be obtained. Thereafter, adding of the photo-setting substance of a predetermined depth and the selective light projection same as above-described manner are repeated while accompanying the descending of the vessel 1, whereby the solid B of a desired configuration may be obtained with a high dimensional accuracy.



## LEGAL STATUS

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